

# DATA SHEET

## SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

General purpose class II

X6S

4 V TO 50 V

100 pF to 47 $\mu$ F

RoHS compliant & Halogen free



**SCOPE**

This specification describes X6S series chip capacitors with lead-free terminations.

**APPLICATIONS**

- PCs, Hard disk, Game PCs
- Power supplies
- DVD players
- Mobile phones
- Data processing

**FEATURES**

- Supplied in tape on reel
- Nickel-barrier end termination
- RoHS compliant
- Halogen free compliant

**ORDERING INFORMATION - GLOBAL PART NUMBER**

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

**YAGEO BRAND ordering code**

**GLOBAL PART NUMBER (PREFERRED)**

**CC** XXXX X X **X6S** X **BB** XXX  
 (1) (2) (3) (4) (5)

**(1) SIZE – INCH BASED (METRIC)**

- 0201 (0603)
- 0402 (1005)
- 0603 (1608)
- 0805 (2012)
- 1206 (3216)
- 1210 (3225)

**(2) TOLERANCE**

- K = ±10%
- M = ±20%

**(3) PACKING STYLE**

- R = Paper/PE taping reel; Reel 7 inch
- K = Blister taping reel; Reel 7 inch
- P = Paper/PE taping reel; Reel 13 inch
- F = Blister taping reel; Reel 13 inch
- C = Bulk case

**(4) RATED VOLTAGE**

- 4 = 4 V
- 5 = 6.3 V
- 6 = 10 V
- 7 = 16 V
- 8 = 25 V
- 9 = 50 V

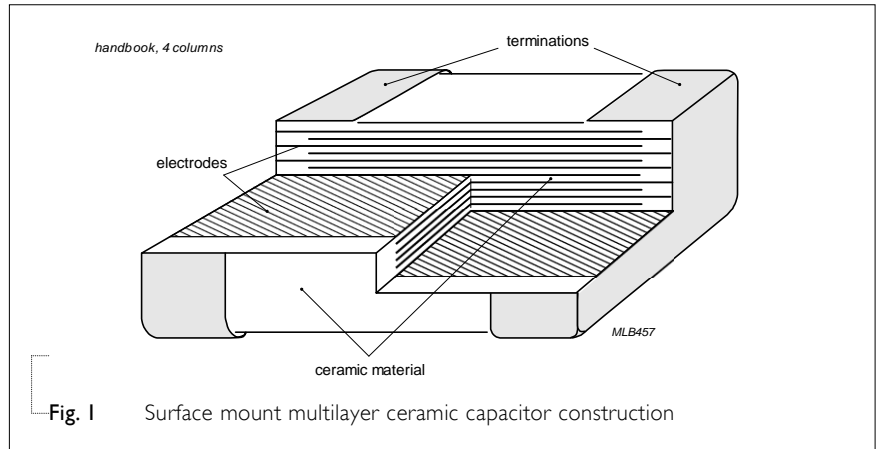
**(5) CAPACITANCE VALUE**

2 significant digits+number of zeros  
 The 3rd digit signifies the multiplying factor, and letter R is decimal point  
 Example: 103 =  $10 \times 10^3 = 10,000 \text{ pF} = 10 \text{ nF}$

**CONSTRUCTION**

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.

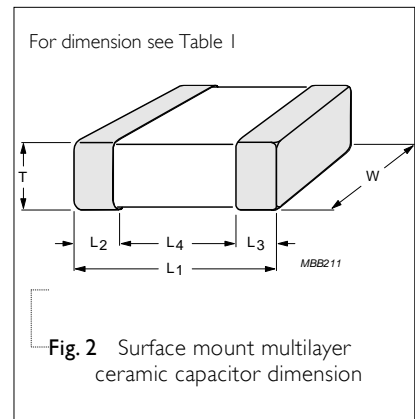


**DIMENSION**

Table I For outlines see fig. 2

TYPE	L <sub>1</sub> (mm)	W (mm)	T (MM)	L <sub>2</sub> / L <sub>3</sub> (mm)		L <sub>4</sub> (mm)
				min.	max.	min.
0201	0.6 ±0.03	0.3 ±0.03	0.3 ±0.03	0.10	0.20	0.20
	0.6 ±0.09	0.3 ±0.09	0.3 ±0.09			
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.30
	1.0 ±0.1	0.5 ±0.1	0.5 ±0.1			
	1.0 ±0.15	0.5 ±0.15	0.5 ±0.15			
	1.0 ±0.20	0.5 ±0.20	0.5 ±0.20			
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40
	1.6 ±0.15	0.8 ±0.15	0.8 ±0.15			
	1.6 ±0.20	0.8 ±0.20	0.8 ±0.20			
0805	2.0 ±0.20	1.25 ±0.20	1.25 ±0.20	0.25	0.75	0.70
1206	3.2 ±0.30	1.6 ±0.20	1.6 ±0.20	0.25	0.75	1.40
1210	3.2 ±0.40	2.5 ±0.30	2.5 ±0.20	0.25	0.75	1.40
	3.2 ±0.40	2.5 ±0.30	2.5 ±0.30			

**OUTLINES**



**CAPACITANCE RANGE & THICKNESS FOR X6S**

Table 2 Sizes from 0201 to 0603

CAP.	0201				0402				0603					
	6.3V	10V	16V	25V	6.3V	10V	16V	25V	4V	6.3V	10V	16V	25V	50V
100 nF	0.3±0.03	0.3±0.03	0.3±0.03	0.3±0.03										
220 nF	0.3±0.03	0.3±0.03			0.5±0.05	0.5±0.05	0.5±0.05	0.5±0.05						
470 nF	0.3±0.09	0.3±0.09			0.5±0.05	0.5±0.05	0.5±0.1							
1 uF	0.3±0.09	0.3±0.09			0.5±0.05	0.5±0.05	0.5±0.1		0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.1	
2.2 uF					0.5±0.20	0.5±0.20			0.8±0.1	0.8±0.1	0.8±0.1	0.8±0.2		
4.7 uF					0.5±0.15				0.8±0.2	0.8±0.2				
10 uF									0.8±0.2	0.8±0.2				
22 uF									0.8±0.2	0.8±0.2				
47 uF														

Table 3 Sizes from 0805 to 1210

CAP.	0805					1206				1210		
	6.3V	10V	16V	25V	50V	6.3V	10V	16V	25V	6.3V	10V	16V
100 nF												
220 nF												
470 nF												
1 uF												
2.2 uF	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2							
4.7 uF	1.25±0.2	1.25±0.2	1.25±0.2	1.25±0.2								
10 uF	1.25±0.2	1.25±0.2	1.25±0.2			1.6±0.2	1.6±0.2	1.6±0.2	1.6±0.2			
22 uF	1.25±0.2					1.6±0.2	1.6±0.2					
47 uF										2.5±0.2	2.5±0.2	
100 uF												

**THICKNESS CLASSES AND PACKING QUANTITY**

Table 4

SIZE CODE	THICKNESS CLASSIFICATION	TAPE WIDTH QUANTITY PER REEL	Ø 180 MM / 7 INCH		Ø 330 MM / 13 INCH		QUANTITY PER BULK CASE
			Paper	Blister	Paper	Blister	
0201	0.3 ±0.03 mm	8 mm	15,000	---	50,000	---	---
0402	0.5 ±0.05 mm	8 mm	10,000	---	50,000	---	50,000
0603	0.8 ±0.1 mm	8 mm	4,000	---	15,000	---	15,000
0805	1.25 ±0.2 mm	8 mm	---	3,000	---	10,000	5,000
1206	1.6 ±0.2 mm	8 mm	---	2,000	---	8,000	---
1210	2.5±0.2/0.3 mm	8 mm	---	500	---	---	---

**ELECTRICAL CHARACTERISTICS**

**X6S DIELECTRIC CAPACITORS; NISN TERMINATIONS**

Unless otherwise specified, all tests and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C
- Relative humidity: 25% to 75%
- Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

Table 5

DESCRIPTION	VALUE
Capacitance range	100 nF to 100 µF
Capacitance tolerance	±10% and ±20%
Dissipation factor (D.F.)	≤10%
Insulation resistance after 1 minute at $U_r$ (DC)	$R_{ins} \times C_r \geq 100 / 50 \Omega.F *$
Maximum capacitance change as a function of temperature (temperature characteristic/coefficient):	±22%
Operating temperature range:	-55 °C to +105 °C

**Note:**

$R_{ins} \times C_r \geq 100 \Omega.F$

0201: 100nF to 470nF

0603: 1uF, 2.2uF/ 6.3V to 16V, 4.7uF/ 6.3V to 16V

0805: 2.2uF, 4.7uF to 10uF/ 6.3V to 16V

1206: 10uF/ 6.3V to 16V, 22uF/ 6.3V to 10V

$R_{ins} \times C_r \geq 50 \Omega.F$

0201: 100nF / 16V to 25V, 1uF

0402: 220nF/ 6.3V to 25V, 470nF/ 6.3V to 16V, 1uF to 2.2uF/ 6.3V to 16V, 4.7uF/ 6.3V

0603: 2.2uF/ 25V, 4.7uF/ 25V, 10uF to 22uF

0805: 4.7uF/ 50V, 10uF/ 25V, 22uF to 47uF

1206: 10uF/ 25V, 22uF/ 16V, 47uF to 100uF

1210: 47uF to 100uF

**SOLDERING RECOMMENDATION**

Table 6

SOLDERING METHOD	SIZE				
	≤ 0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	≥ 1.0 μF	≥ 2.2 μF	≥ 4.7 μF	Reflow only
Reflow/Wave	---	< 1.0 μF	< 2.2 μF	< 4.7 μF	---

**TESTS AND REQUIREMENTS**

Table 7 Test procedures and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384-21/22 4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual Inspection and Dimension Check	IEC 60384-21/22 4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance <sup>(1)</sup>	IEC 60384-21/22 4.5.1	Class 2: At 20 °C, 24 hrs after annealing Cap ≤ 1 μF, f = 1 KHz, measuring at voltage 1 Vrms at 20 °C Cap > 1 μF, f = 1 KHz for C ≤ 10 μF, rated voltage > 6.3 V, measuring at voltage 1 Vrms at 20 °C f = 1 KHz, for C ≤ 10 μF, rated voltage ≤ 6.3 V, measuring at voltage 0.5 to 1 Vrms at 20 °C f = 120 Hz for C > 10 μF, measuring at voltage 0.5 Vrms at 20 °C	Within specified tolerance
Dissipation Factor (D.F.) <sup>(1)</sup>	IEC 60384-21/22 4.5.2	Class 2: At 20 °C, 24 hrs after annealing Cap ≤ 1 μF, f = 1 KHz, measuring at voltage 1 Vrms at 20 °C Cap > 1 μF, f = 1 KHz for C ≤ 10 μF, rated voltage > 6.3 V, measuring at voltage 1 Vrms at 20 °C f = 1 KHz, for C ≤ 10 μF, rated voltage ≤ 6.3 V, measuring at voltage 0.5 Vrms at 20 °C f = 120 Hz for C > 10 μF, measuring at voltage 0.5 Vrms at 20 °C	In accordance with specification
Insulation Resistance	IEC 60384-21/22 4.5.3	At U <sub>r</sub> (DC) for 1 minute	In accordance with specification

**NOTE**

1. The figure indicates typical inspection. Please refer to individual specifications.

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS									
Temperature Characteristic	IEC 60384-21/22	4.6 Capacitance shall be measured by the steps shown in the following table.  The capacitance change should be measured after 5 min at each specified temperature stage.	X6S: $\Delta C/C$ : $\pm 22\%$									
				<table border="1" style="margin-left: auto; margin-right: auto;"> <tr> <th>Step</th> <th>Temperature(°C)</th> </tr> <tr> <td>a</td> <td>25±2</td> </tr> <tr> <td>b</td> <td>Lower temperature±3°C</td> </tr> <tr> <td>c</td> <td>25±2</td> </tr> <tr> <td>d</td> <td>Upper Temperature±2°C</td> </tr> <tr> <td>e</td> <td>25±2</td> </tr> </table> <p style="margin-left: 40px;">Class II</p> <p style="margin-left: 40px;">Capacitance Change shall be calculated from the formula as below</p> $\Delta C = \frac{C2 - C1}{C1} \times 100\%$ <p style="margin-left: 40px;">C1: Capacitance at step c C2: Capacitance at step b or d</p>	Step	Temperature(°C)	a	25±2	b	Lower temperature±3°C	c	25±2
Step	Temperature(°C)											
a	25±2											
b	Lower temperature±3°C											
c	25±2											
d	Upper Temperature±2°C											
e	25±2											
Adhesion	IEC 60384-21/22	4.7 A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate	Force size ≥ 0603: 5N size = 0402: 2.5N size = 0201: 1N									
Bending Strength	IEC 60384-21/22	4.8 Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage									
			Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 5 mm	$\Delta C/C$ X6S: $\pm 10\%$								

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
<b>Resistance to Soldering Heat</b>	IEC 60384-21/22 4.9	<p>Precondition: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature</p> <p>Preheating: for size ≤ 1206: 120 °C to 150 °C for 1 minute</p> <p>Preheating: for size &gt;1206: 100 °C to 120 °C for 1 minute and 170 °C to 200 °C for 1 minute</p> <p>Solder bath temperature: 260 ±5 °C</p> <p>Dipping time: 10 ±0.5 seconds</p> <p>Recovery time: 24 ±2 hours</p>	<p>Dissolution of the end face plating shall not exceed 25% of the length of the edge concerned</p> <hr/> <p>ΔC/C</p> <p>X6S: ±10%</p> <hr/> <p>D.F. within initial specified value</p> <p>R<sub>ins</sub> within initial specified value</p>
<b>Solderability</b>	IEC 60384-21/22 4.10	<p>Preheated the temperature of 80 °C to 140 °C and maintained for 30 seconds to 60 seconds.</p> <p>1. Temperature: 235±5°C / Dipping time: 2 ±0.5 s</p> <p>2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)</p> <p>Depth of immersion: 10mm</p>	<p>The solder should cover over 95% of the critical area of each termination</p>
<b>Rapid Change of Temperature</b>	IEC 60384-21/22 4.11	<p>Preconditioning: 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature</p> <p>5 cycles with following detail: 30 minutes at lower category temperature 30 minutes at upper category temperature</p> <p>Recovery time 24 ±2 hours</p>	<p>No visual damage</p> <hr/> <p>ΔC/C</p> <p>X6S: ±15%</p> <hr/> <p>D.F. meet initial specified value</p> <p>R<sub>ins</sub> meet initial specified value</p>

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Damp Heat with U <sub>r</sub> Load	IEC 60384-21/22 4.13	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Damp heat test: 500 ±12 hours at 40 ±2 °C; 90 to 95% R.H. 1.0 U <sub>r</sub> applied 4. Recovery: Class 2: 24 ±2 hours 5. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirements shall be met.	No visual damage after recovery <hr/> ΔC/C ±20% D.F. 2 × initial value max R <sub>ins</sub> Rins × Cr ≥ 5s
Endurance	IEC 60384-21/22 4.14	1. Preconditioning, class 2 only: 150 +0/-10 °C /1 hour, then keep for 24 ±1 hour at room temp 2. Initial measure: Spec: refer to initial spec C, D, IR 3. Endurance test: Temperature: X6S: 105 °C Specified stress voltage applied for 1,000 hours: Applied 1.5 × Ur. Applied 1 Ur: 0201: 1uF 0402: 4.7uF, 10uF 0603: 10uF, 22uF 0805: 10uF/ 25V, 22uF/ 10V to 16V Recovery time: 24 ±2 hours 4. Final measure: C, D, IR P.S. If the capacitance value is less than the minimum value permitted, then after the other measurements have been made the capacitor shall be preconditioned according to "IEC 60384 4.1" and then the requirements shall be met.	No visual damage <hr/> ΔC/C ±20% D.F. 2 × initial value max R <sub>ins</sub> Rins × Cr ≥ 10s
Voltage Proof	IEC 60384-1 4.6	Specified stress voltage applied for 1~5 seconds Ur ≤ 100 V: series applied 2.5 Ur Charge/Discharge current is less than 50 mA	No breakdown or flashover

**REVISION HISTORY**

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 7	Feb. 07, 2023	-	- Product range updated
Version 6	Jan. 20, 2021	-	- Product range updated
Version 5	Jun. 2, 2020	-	- Product range updated
Version 4	Aug 7, 2017	-	- 0402 Dimension update
Version 3	Jul 19, 2017	-	- Product range updated
Version 2	Feb. 20, 2017	-	- Dimension & capacitance update
Version 1	Sep. 16, 2015	-	- Dimension & capacitance update
Version 0	Nov. 18, 2014	-	- New datasheet for general purpose High Cap X6S

单击下面可查看定价，库存，交付和生命周期等信息

[>>Yageo\(国巨\)](#)